



Click [here](#) for the 3D model.

General Information

Series	CBR05 SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Notes	Solder Reflow Only.
Shelf Life	78 Weeks
MSL	1

Dimensions

Chip Size	0505
L	1.4mm +0.38/-0.25mm
W	1.4mm +/-0.38mm
T	1.15mm +/-0.15mm
B	0.25mm +0.25/-0.13mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	3000

Specifications

Capacitance	1.8 pF
Tolerance	+/-0.1 pF
Voltage DC	250 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	836

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.